**Newsletter of Technical Committee on Cybernetics for Cyber-Physical Systems (IEEE SMC Society)**

**Call for Contributions**

The newsletter of Technical Committee on Cybernetics for Cyber-Physical Systems (TCCCPS) aims to provide timely updates on technologies, educations and opportunities in the field of cyber-physical systems (CPS). The letter will be published twice a year: one issue in February and the other issue in October. We are soliciting contributions to the newsletter. Topics of interest include (but are not limited to):

* Embedded system design for CPS
* Real-time system design and scheduling for CPS
* Distributed computing and control for CPS
* Resilient and robust system design for CPS
* Security issues for CPS
* Formal methods for modeling and verification for CPS
* Emerging applications such as automotive system, smart grid, etc.

Please directly contact the editors and/or associate editors by email to submit your contributions.

**Submission Deadline:**

All contributions must be submitted by January 1, 2016 in order to be included in the February issue of the newsletter.

**Editors:**

* Xin Li, Carnegie Mellon University, USA, [xinli@cmu.edu](mailto:xinli@cmu.edu)

**Associate Editors:**

* Yier Jin, University of Central Florida, USA, [yier.jin@eecs.ucf.edu](mailto:yier.jin@eecs.ucf.edu)
* Rajiv Ranjan, Commonwealth Scientific and Industrial Research Organization, Australia, [rajiv.ranjan@csiro.au](mailto:rajiv.ranjan@csiro.au)
* Yiyu Shi, Missouri University of Science and Technology, USA, [yshi@mst.edu](mailto:yshi@mst.edu)
* Bei Yu, Chinese University of Hong Kong, Hong Kong, [disyulei@gmail.com](mailto:disyulei@gmail.com)
* Qi Zhu, University of California at Riverside, USA, [qzhu@ece.ucr.edu](mailto:qzhu@ece.ucr.edu)